Data sheet Product EMB215_



Cases>Heat dissipating case
Embedded case
contents of delivery: 1 = 1 x case profile; **2** = 2 x cover panel; **3** = 1 x bottom panel; **4** = mounting material

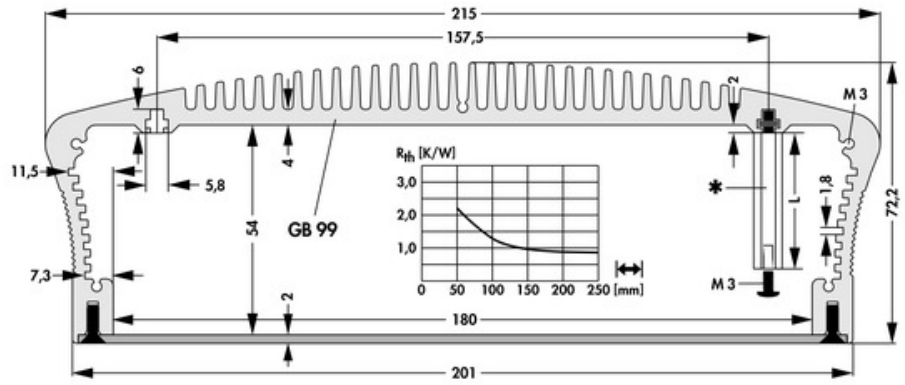
- universal cooling fin case made of aluminium extruded profile, cover panels in 2 mm thickness and removable bottom panel
- optimized heat dissipation by means of external cooling fins
- the integrated T-grooves in the case profile for mounting of i.e. mainboards in the **Mini-ITX** or **NUC** form factor by means of distance, bolts and mounting plate also **EBX, Nano ITX, EPIC, ETX/XTX** and **PC/104** form factors by means
- internal guide grooves for inserting PCBs or mounting plates
- wall-, ceiling- or top-hat rail mounting by means of fixing straps or top-hat rail mounting from the bottom
- special designs, embedded cover panels, machinings, surfaces and printings upon request

*** accessories mounting set BFS**

Features

surface:	• **black anodised** • **natural colour anodised** • **case profile SA, cover panels ME**
way of fixation (optional):	• **fixing of mounting rail** • **mounting strap set**

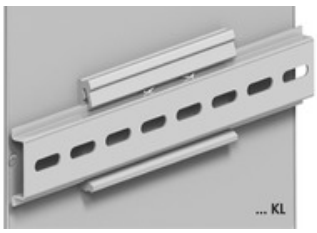
Technical Drawing

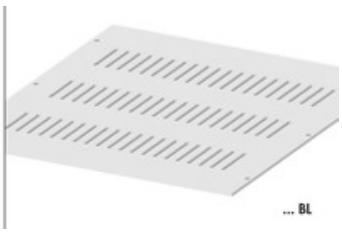


length: **150 mm / 200 mm / 250 mm**

Further Information







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